belkin

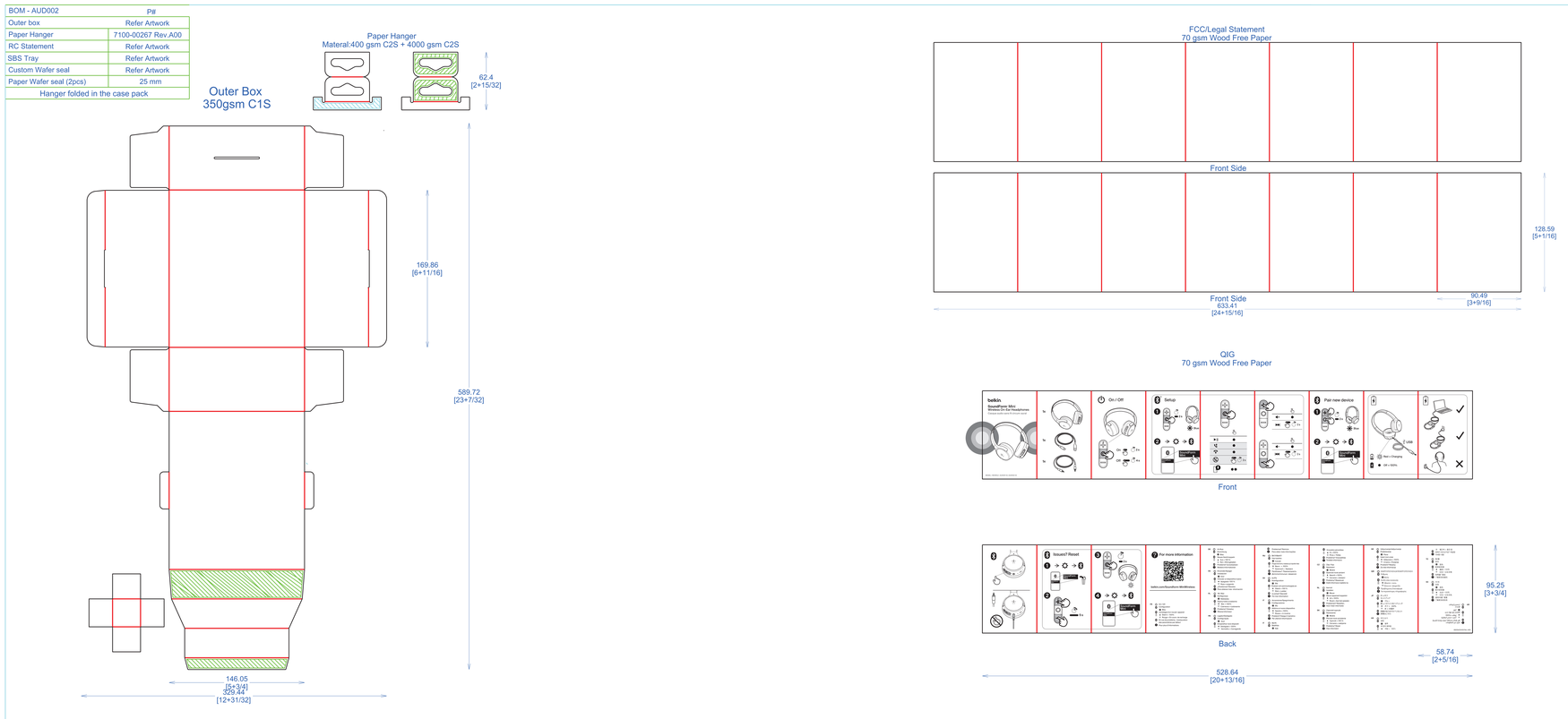
Die Line File: IDL_AUD002_ON EAR WIRELESS HEADPHONE

Artwork File:

REV 0 00

DIE LAYOUT

BOM - AUD002	P#
Outer box	Refer Artwork
Paper Hanger	7100-00267 Rev.A00
RC Statement	Refer Artwork
SBS Tray	Refer Artwork
Custom Wafer seal	Refer Artwork
Paper Wafer seal (2pcs)	25 mm
Hanger folded in the case pack	



Business Unit: Core

Program Manager: Andrew Camba

Packaging Engineer: Matthew Duffy

Retail Outside Dimension (Including Hang Tab)

L x W x D (in):

L x W x D (mm):

DIE/MATERIAL SPECS:

Material: Please refer to drawing

Blank Size (in): 60+57/64 x 26.641

Blank Size (mm): 1546.610 x 676.692

This dieline works for following skus (if any):

Unit: IN/MM

Side Shown: PRINT SIDE

Flute/Grain: horizontal

Tolerance:+/- 1/32" - 0.8mm

Drawing Scale 1:1

RELEASE DATE: 05/22/2023

DIELINE:

Intermediate

PRINT SPECS:

Color Plates:

Finish:

Notes:

DO NOT PRINT
DIE LINES, PRINTERS NOTES